PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

| Name | Execution Date |
|-----------------|----------------|
| Koichiro Tanaka | 04/14/2009 |

RECEIVING PARTY DATA

| Name: | Semiconductor Energy Laboratory Co., Ltd. | |
|-----------------|---|--|
| Street Address: | 398, Hase | |
| City: | Atsugi-shi, Kanagawa-ken | |
| State/Country: | JAPAN | |
| Postal Code: | 243-0036 | |

PROPERTY NUMBERS Total: 1

| Property Type | Number |
|---------------------|----------|
| Application Number: | 12431264 |

CORRESPONDENCE DATA

Fax Number: (877)769-7945

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

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ATTORNEY DOCKET NUMBER: 12732-0610001

NAME OF SUBMITTER: April K. Saunders-Fuller

Total Attachments: 1

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PATENT REEL: 022635 FRAME: 0203

ASSIGNMENT

For valuable consideration, I, <u>Koichiro TANAKA of Isehara</u>, <u>Kanagawa</u>, <u>Japan</u> hereby assign to <u>Semiconductor Energy Laboratory Co.</u>, <u>Lid.</u>, a <u>Japanese</u> corporation having a place of business at:

398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan

| and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and |
|--|
| interest throughout the world in the inventions and improvements which are subject of an application for |
| United States Patent signed by me this day, entitled <u>DEPOSITION DONOR SUBSTRATE AND</u> |
| DEPOSITION METHOD USING THE SAME, filed April 28, 2009 , and assigned U.S. Serial |
| Number 12/431,264, and I authorize and request the Assignee or the attorneys appointed in |
| said application to hereafter complete this assignment by inserting above the filing date and serial number of |
| said application when known; this assignment including said application, any and all United States and |
| foreign patents, utility models, and design registrations granted for any of said inventions or improvements, |
| and the right to claim priority based on the filing date of said application under the International Convention |
| for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and |
| all other treaties of like purposes; and I authorize the Assignce to apply in all countries in my name or in its |
| own name for patents, utility models, design registrations and like rights of exclusion and for inventors' |
| certificates for said inventions and improvements; and I agree for myself and my respective heirs, legal |
| representatives and assigns, without further compensation to perform such lawful acts and to sign such |
| further applications, assignments, Preliminary Statements and other lawful documents as the Assignee may |
| reasonably request to effectuate fully this assignment. |
| |

Signature Co; ch; TANAKA

Name: Koichiro TANAKA

Date: Of //4 / 200 9

PATENT
RECORDED: 05/04/2009 REEL: 022635 FRAME: 0204